

Overview

KEMET's epoxy molded axial through-hole ceramic capacitors in COG dielectric feature a 125°C maximum operating temperature. The Electronics Industries Alliance (EIA) characterizes COG dielectric as a Class I "stable" material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and stability of capacitance characteristics

are required. COG exhibits no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient temperature. Capacitance change is limited to ± 30 ppm/°C from -55°C to ± 125 °C. These devices meet the flame test requirements outlined in UL Standard 94 V–0.

Benefits

- · Axial through-hole form factor
- Molded case
- -55°C to +125°C operating temperature range
- DC voltage ratings of 50V, 100 V and 200 V
- Capacitance offerings ranging from 1.0 pF up to 0.10 μ F
- Available capacitance tolerances of ± 0.5 pF, $\pm 1\%,$ $\pm 2\%,$ $\pm 5\%,$ and $\pm 10\%$
- No piezoelectric noise
- Extremely low ESR and ESL
- High thermal stability
- High ripple current capability

Ordering Information

- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +125°C
- · No capacitance decay with time
- · Non-polar device, minimizing installation concerns
- SnPb-plated lead finish (60/40)
- Encapsulation meets flammability standard UL 94 V-0



С	114	С	681	F	1	G	5	С	Α	7200
Ceramic	Style /Size	Specification /Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Design	Lead Finish ²	Failure Rate	Packaging /Grade (C-Spec)
	114 124 192 202 222	C = Standard	Two significant digits and number of zeros Use 9 for 1.0 - 9.9 pF Use 8 for 0.5 - 0.99 pF ex. 2.2 pF = 229 ex. 0.5 pF = 508	•	5 = 50 V 1 = 100 V 2 = 200 V	G = COG	5 = Multilayer	C = SnPb (60/40)	A = N/A	Blank = Bulk 7200 = 12" Reel 7293 = Ammo Pack

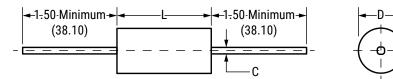
¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details. ² Lead materials:

Standard: 60% tin (Sn)/40% lead (Pb) finish with 100% copper core ("C" designation). Alternative lead materials and finishes may be available. Contact KEMET for details.

C1045 COG AXIAL MOLDED • 12/15/2022



Dimensions – Inches (Millimeters)



Series	Style/Size	L Length Maximum	D Diameter Maximum	LD Lead Diameter	LL Lead Length Minimum
	114	0.160±0.010 (4.06±0.25)	0.090±0.010 (2.29±0.25)	0.020+0.0/-0.003	
C1XX	124	0.250±0.010 (6.35±0.25)	0.090±0.010 (2.29±0.25)	(0.51+0.0/-0.08)	
	192	0.390±0.010 (9.91±0.25)	0.140±0.010 (3.56±0.25)	0.005.0.004/.0.001	1.50 (38.10)
00777	202	0.500±0.020 (12.70±0.51)	0.250±0.015 (6.35±0.38)	0.025+0.004/-0.001 (0.64+0.10/-0.025)	
C2XX	222	0.690±0.030 (17.53±0.76)	0.350±0.020 (8.89±0.51)	(0.0410.10/ 0.020)	

Applications

Typical applications include critical timing, tuning, circuits requiring low loss, circuits with pulse, high current, decoupling, bypass, filtering, transient voltage suppression, blocking and energy storage.

Application Notes

These devices are not recommended for use in overmold applications and/or processes.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 2, Performance & Reliability.

Environmental Compliance

These devices do not meet RoHS criteria due to the concentration of Pb containment in the lead finish.



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Max % Cap Loss/Decade Hour)	0%
Dielectric Withstanding Voltage	250% of rated voltage (5 ±1 second and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 GΩ (Rated voltage applied for 120 ±5 seconds at 25°C)

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits.

Capacitance and dissipation factor (DF) measured under the following conditions:

1 MHz ±100 kHz and 1.0 V_{rms} ±0.2 V if capacitance ≤ 1,000 pF

1 kHz ±50 Hz and 1.0 V_{rms} ±0.2 V if capacitance > 1,000 pF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

High Temperature Life, Biased Humidity, Moisture Resistance						
Dielectric Rated DC Voltage Capacitance Value DF (%) Capacitance Shift						
COG	All	All	0.5	0.3% or ±0.25 pF		



Table 1A - C114 Style/Size (0.090" Diameter x 0.160" L), Capacitance Range Waterfall

C114 Style/Size (0.090" Diameter x 0.160" L)					
Rated Voltage (VDC)		50	100	200	
Voltag	e Code	5	1	2	
Capacitance	Capacitance Tolerance	Capaci	tance Code (Available C	apacitance)	
1pF		109	109	109	
1.5pF		159	159	159	
2.2pF		229	229	229	
2.7pF		279	279	279	
3.3pF	D = ±0.5pF	339	339	339	
3.9pF	D - 10.5pr	399	399	399	
4.7pF		479	479	479	
5.6pF		569	569	569	
6.8pF		689	689	689	
8.2pF		829	829	829	
10pF	J = ±5% K = ±10%	100	100	100	
12pF		120	120	120	
15pF		150	150	150	
18pF		180	180	180	
22pF	1	220	220	220	
27pF	000	270	270	270	
33pF	G = ±2% J = ±5%	330	330	330	
39pF	J = ±5% K = ±10%	390	390	390	
47pF	K = ±10%	470	470	470	
56pF		560	560	560	
68pF	1	680	680	680	
82pF		820	820	820	
100pF		101	101	101	
120pF		121	121	121	
150pF	F = ±1%	151	151	151	
180pF	G = ±2%	181	181	181	
220pF	J = ±5%	221	221	221	
270pF	K = ±10%	271	271	271	
330pF		331	331	331	
390pF		391	391		
470pF		471	471		
560pF		561	561		
680pF		681	681		
	tage (VDC)	50	100	200	
	e Code	5	1	2	



Table 1B - C124 Style/Size (0.090" Diameter x 0.250" L), Capacitance Range Waterfall

C124 Style/Size (0.090" Diameter x 0.250" L)					
Rated Voltage (VDC)	50	100	200	
Voltage Code	Voltage Code		1	2	
Capacitance	Capacitance Capacitance Tolerance		Capacitance Code (Available Capacitance)		
390pF		391	391	391	
470pF	F = ±1%	471	471	471	
560pF	G = ±2%	561	561	561	
680pF	J = ±5%				
820pF	K = ±10%	821	821		
1000pF		102	102		
Rated Voltage (VDC	Rated Voltage (VDC)		100	200	
Voltage Code	Voltage Code		1	2	

Table 1C - C192 Style/Size (0.140" Diameter x 0.390" L), Capacitance Range Waterfall

C192 Style/Size (0.140" Diameter x 0.390" L)					
Rated Voltage (VD	IC)	50	100	200	
Voltage Code		5	1	2	
Capacitance	Capacitance Capacitance Tolerance		citance Code (Available C	apacitance)	
680pF		681	681	681	
820pF		821	821	821	
1000pF		102	102	102	
1200pF		122	122	122	
1500pF		152	152	152	
1800pF		182	182	182	
2200pF	F = ±1%	222	222	222	
2700pF	G = ±2%	272	272	272	
3300pF	J = ±5%	332	332	332	
2700pF	K = ±10%	272	272	272	
3300pF		332	332	332	
3900pF		392	392	392	
4700pF		472	472	472	
5600pF		562	562		
6800pF		682	682		
8200pF		822	822		
Rated Voltage (VD)C)	50	100	200	
Voltage Code		5	1	2	



Table 1D - C202 Style/Size (0.250" Diameter x 0.500" L), Capacitance Range Waterfall

C202 Style/Size (0.250" Diameter x 0.500" L)					
Rated Voltage (VDC)	50	100	200	
Voltage Code		5	1	2	
Capacitance Capacitance Tolerance		Сара	citance Code (Available C	apacitance)	
5600pF		562	562	562	
6800pF		682	682	682	
8200pF		822	822	822	
0.01µF	F = ±1%	103	103	103	
0.012µF	G = ±2%	123	123	123	
0.015µF	J = ±5%	153	153	153	
0.018µF	K = ±10%	183	183	183	
0.022µF		223	223	223	
0.027µF		273	273		
0.033µF		333	333		
Rated Voltage (VDC)	50	100	200	
Voltage Code		5	1	2	

Table 1E – C222 Style/Size (0.350" Diameter x 0.690" L), Capacitance Range Waterfall

C222 Style/Size (0.350" Diameter x 0.690" L)					
Rated Voltage (VDC)	50	100	200	
Voltage Code		5	1	2	
Capacitance	Capacitance Capacitance Tolerance		citance Code (Available C	Capacitance)	
0.027µF		273	273	273	
0.033µF		333	333	333	
0.039µF	F = ±1%	393	393	393	
0.047µF	G = ±2%	473	473	473	
0.056µF	J = ±5%	563	563		
0.068µF	K = ±10%	683	683		
0.082µF		823	823		
0.1µF		104	104		
Rated Voltage (VDC)	50	100	200	
Voltage Code		5	1	2	



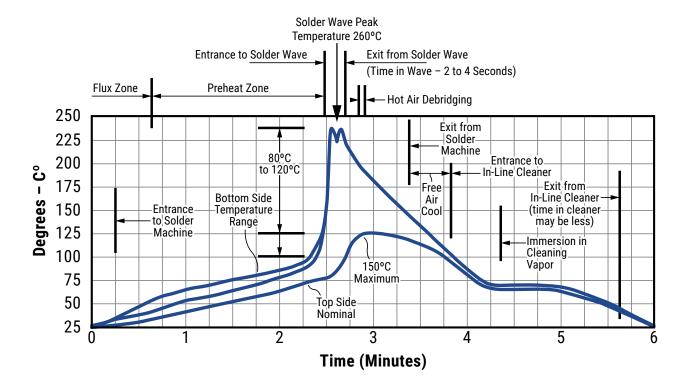
Soldering Process

Recommended Soldering Technique:

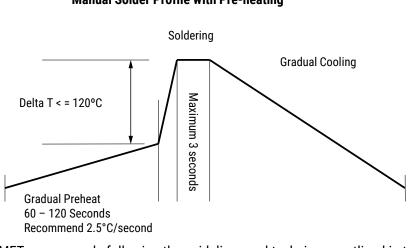
- · Solder Wave
- Hand Soldering (Manual)

Recommended Soldering Profile:

• Optimum Wave Solder Profile



• Hand Soldering (Manual)



Manual Solder Profile with Pre-heating

KEMET recommends following the guidelines and techniques outlined in technical bulletins F2103 and F9207.



Table 2 – Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method
		Magnification 50 X. Conditions:
	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Solderability	J-51D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C), Measurement at 24 hours. +/-2 hours after test conclusion.
	MIL-STD-202 Method	Load Humidity: 1,000 hours 85°C/85% RH and Rated Voltage. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Biased Humidity 103		Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours. +/-2 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108 /EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC, for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10–2,000 Hz.
Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B. No pre-heat of samples. Note: single wave solder - procedure 2.
Terminal Strength	MIL-STD-202 Method 211	Conditions A (2.3kg or 5 lbs)
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature-reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C, and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years of receipt.



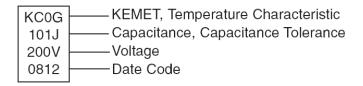
Packaging Details

Lead Spacing	Component Pitch (P1)
0.100 (2.54)	5.08
0.200 (5.08)	3.81
0.400 (10.16)	7.62
0.170 (4.32)	
0.220 (5.59)	
0.275 (6.98)	
0.300 (7.62)	
0.375 (9.52)	
0.475 (12.06)	
0.575 (14.60)	
0.675 (17.14)	

Packaging Quantities

Style/Size	Standard Bulk Quantity	Ammo Pack Quantity Maximum	Reel Quantity Maximum (12" Reel)
114	200/Box		5000
124	200/Box		5000
192	100/Box	N/A	3000
202	25/Box		500
222	10/Tray		300

Marking

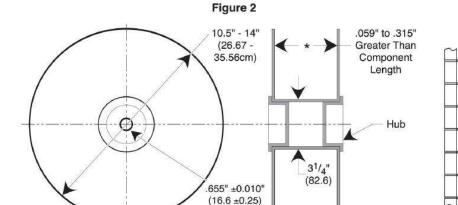


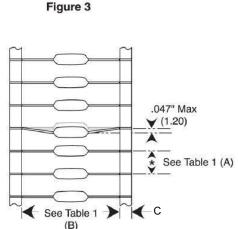


Tape & Reel Packaging Information

KEMET offers standard reeling of molded and conformally coated axial leaded ceramic capacitors for automatic insertion or lead forming machines in accordance with EIA standard 296. KEMET's internal specification four-digit suffix, 7200, is placed at the end of the part number to designate tape and reel packaging, e.g., C410C104Z5U5TA7200.

Paper (50 lb.) test minimum is inserted between the layers of capacitors wound on reels for component pitch ≤ 0.400 ". Capacitor lead length may extend only a maximum of .0625" (1.59 mm) beyond the tapes' edges. Capacitors are centered in a row between the two tapes and will deviate only \pm 0.031" (0.79 mm) from the row center. A minimum of 36" (91.5 cm) leader tape is provided at each finished length of taped components. Universal splicing clips are used to connect the tape.





Kraft Paper Interleaving

Figure 1

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Table 3 – Ceramic Axial Tape and Reel Dimensions Metric will govern

Dimensions – Millimeters (Inches)			
Axial Capacitor Body Diameter	A ±0.5 (0.020)	B ±1.5 (0.059) ¹	C ±0.70 (0.028)
0.0 to 5.0 (0.0 to 0.197)	5.0 (0.197)	52.4 (2.062)	6.35 (0.250)

Symbol Reference Table		
A	Component Pitch	
В	Inside Tape Spacing	
С	Tape Width	

¹ Inside tape spacing dimension (B) is determined by the body diameter of the capacitor.

Adhesive Tape



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